CMLD4448DO CMLD4448DOG

SURFACE MOUNT SILICON DUAL, ISOLATED, OPPOSING HIGH SPEED SWITCHING DIODES



• The CMLD4448DOG is *Halogen Free* by design



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DESCRIPTION:

The CENTRAL SEMICONDUCTOR CMLD4448DO and CMLD4448DOG each contain two (2) isolated opposing configuration, silicon switching diodes, manufactured by the epitaxial planar process, epoxy molded in an SOT-563 surface mount package. These devices are designed for high speed switching applications.

MARKING CODES: CMLD4448DO: C40 CMLD4448DOG: 4CG

MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS
Peak Repetitive Reverse Voltage	V_{RRM}	120	V
Continuous Forward Current	l _F	250	mA
Peak Repetitive Forward Current	I _{FRM}	500	mA
Peak Forward Surge Current, tp=1.0µs	I _{FSM}	4.0	Α
Peak Forward Surge Current, tp=1.0s	I _{FSM}	1.0	Α
Power Dissipation	P_{D}	250	mW
Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C
Thermal Resistance	$\Theta_{\sf JA}$	500	°C/W

ELECTRICAL CHARACTERISTICS PER DIODE: (T_A=25°C unless otherwise noted)

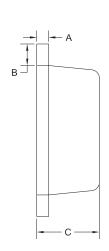
SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS
I_{R}	V _R =50V			300	nA
I_{R}	V _R =50V, T _A =125°C			100	μΑ
I_{R}	V _R =100V			500	nA
BV_R	I _R =100μA	120	150		V
V_{F}	I _F =1.0mA	0.55	0.59	0.65	V
V_{F}	I _F =10mA	0.67	0.72	0.77	V
V_{F}	I _F =100mA	0.85	0.91	1.0	V
CJ	$V_R=0$, f=1.0MHz			1.5	pF
t _{rr}	$I_R=I_F=10$ mA, $I_{rr}=1.0$ mA, $R_L=100$ Ω		2.0	4.0	ns

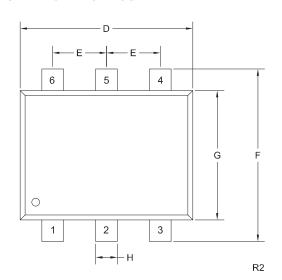
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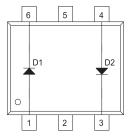


SOT-563 CASE - MECHANICAL OUTLINE





PIN CONFIGURATION



DIMENSIONS						
	INCHES		MILLIMETERS			
SYMBOL	MIN	MAX	MIN	MAX		
Α	0.0027	0.007	0.07	0.18		
В	0.008		0.20			
С	0.017	0.024	0.45	0.60		
D	0.059	0.067	1.50	1.70		
E	0.020		0.50			
F	0.059	0.067	1.50	1.70		
G	0.043	0.051	1.10	1.30		
Н	0.006	0.012	0.15	0.30		
SOT-563 (REV: R2)						

LEAD CODE:

- 1) Anode D1
- 2) NC
- 3) Cathode D2
- 4) Anode D2
- 5) NC
- 6) Cathode D1

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R6 (15-June 2015)

OUTSTANDING SUPPORT AND SUPERIOR SERVICES



PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

DESIGNER SUPPORT/SERVICES

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2nd day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- · Custom product and package development

REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

CONTACT US

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